



## 150V 10.6mΩ N-Ch Power MOSFET

### Features

- Low  $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100%  $R_g$  Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant

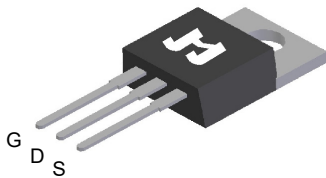
### Product Summary

Parameter	Value	Unit
$V_{DS}$	150	V
$V_{GS(th\_Typ)}$	3.2	V
$I_D$ (@ $V_{GS} = 10V$ ) <sup>(1)</sup>	69	A
$R_{DS(ON\_Typ)}$ (@ $V_{GS} = 10V$ )	10.6	mΩ

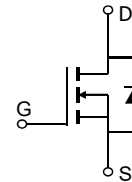
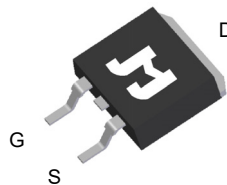
### Applications

- Power Management in Telecom., Industrial Automation, CE
- Current Switching in DC/DC & AC/DC (SR) Sub-systems
- Motor Driving in Power Tool, E-vehicle, Robotics

TO-220-3L Top View



TO-263-3L Top View

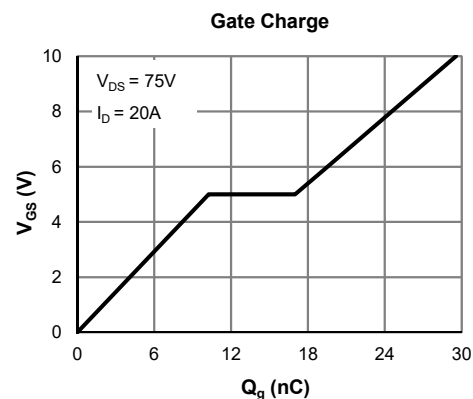
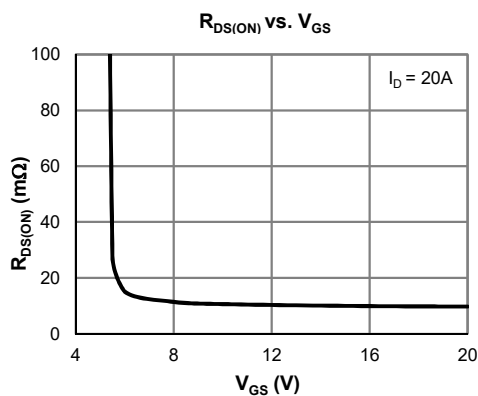


### Ordering Information

Device	Package	# of Pins	Marking	MSL	$T_J$ (°C)	Media	Quantity (pcs)
JMSH1513AC-U	TO-220-3L	3	SH1513A	N/A	-55 to 150	Tube	50
JMSH1513AE-13	TO-263-3L	3	SH1513A	1	-55 to 150	13-inch Reel	800

### Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	$V_{DS}$	150	V
Gate-to-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current <sup>(1)</sup>	$I_D$	$T_C = 25^\circ\text{C}$	69
		$T_C = 100^\circ\text{C}$	43
Pulsed Drain Current <sup>(2)</sup>	$I_{DM}$	232	A
Avalanche Current <sup>(3)</sup>	$I_{AS}$	34	A
Avalanche Energy <sup>(3)</sup>	$E_{AS}$	173	mJ
Power Dissipation <sup>(4)</sup>	$P_D$	$T_C = 25^\circ\text{C}$	139
		$T_C = 100^\circ\text{C}$	56
Junction & Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C





**Electrical Characteristics** (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	150			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 120\text{V}, V_{GS} = 0\text{V}$ $T_J = 55^\circ\text{C}$			1.0 5.0	$\mu\text{A}$
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.5	3.2	4.5	V
Static Drain-Source ON-Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}, I_D = 20\text{A}$	TO-263-3L	10.6	13.3	m $\Omega$
			TO-220-3L	10.8	13.7	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 5\text{V}, I_D = 20\text{A}$		48		S
Diode Forward Voltage	$V_{SD}$	$I_S = 1\text{A}, V_{GS} = 0\text{V}$		0.71	1.0	V
Diode Continuous Current	$I_S$	$T_C = 25^\circ\text{C}$			139	A
<b>DYNAMIC PARAMETERS</b> <sup>(5)</sup>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 75\text{V}, f = 1\text{MHz}$		2128		pF
Output Capacitance	$C_{oss}$			274		pF
Reverse Transfer Capacitance	$C_{rss}$			9.0		pF
Gate Resistance	$R_g$	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$		1.9		$\Omega$
<b>SWITCHING PARAMETERS</b> <sup>(5)</sup>						
Total Gate Charge (@ $V_{GS} = 10\text{V}$ )	$Q_g$	$V_{GS} = 0 \text{ to } 10\text{V}$ $V_{DS} = 75\text{V}, I_D = 20\text{A}$		30		nC
Total Gate Charge (@ $V_{GS} = 6.0\text{V}$ )	$Q_g$			19.5		nC
Gate Source Charge	$Q_{gs}$			10.3		nC
Gate Drain Charge	$Q_{gd}$			6.8		nC
Turn-On Delay Time	$t_{D(on)}$	$V_{GS} = 10\text{V}, V_{DS} = 75\text{V}$ $R_L = 3.75\Omega, R_{GEN} = 6\Omega$		22		ns
Turn-On Rise Time	$t_r$			58		ns
Turn-Off Delay Time	$t_{D(off)}$			33		ns
Turn-Off Fall Time	$t_f$			20		ns
Body Diode Reverse Recovery Time	$t_{rr}$		$I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{S}$		86	
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{S}$		161		nC

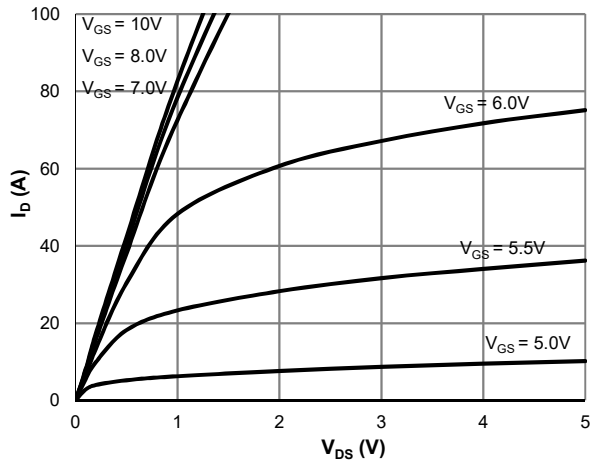
**Thermal Performance**

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	60	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.70	0.90	$^\circ\text{C}/\text{W}$

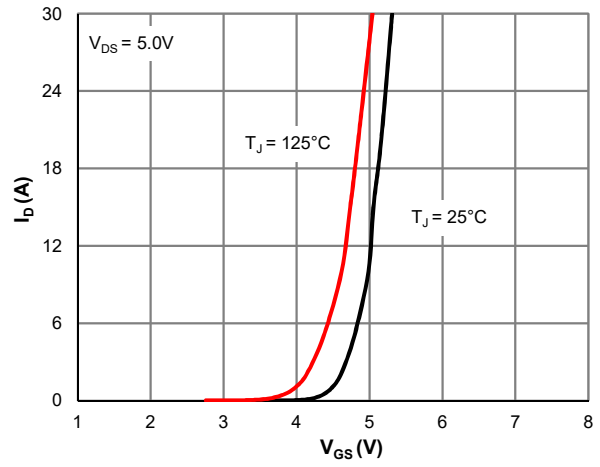
**Notes:**

1. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J\_Max} = 150^\circ\text{C}$ .
3. This single-pulse measurement was taken under the following condition [L = 300 $\mu\text{H}$ ,  $V_{GS} = 10\text{V}$ ,  $V_{DS} = 75\text{V}$ ] while its value is limited by  $T_{J\_Max} = 150^\circ\text{C}$ .
4. The power dissipation  $P_D$  is based on  $T_{J\_Max} = 150^\circ\text{C}$ .
5. This value is guaranteed by design hence it is not included in the production test.

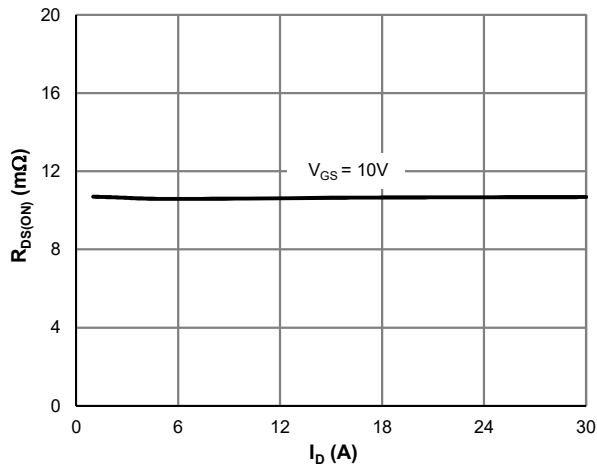
**Typical Electrical & Thermal Characteristics**



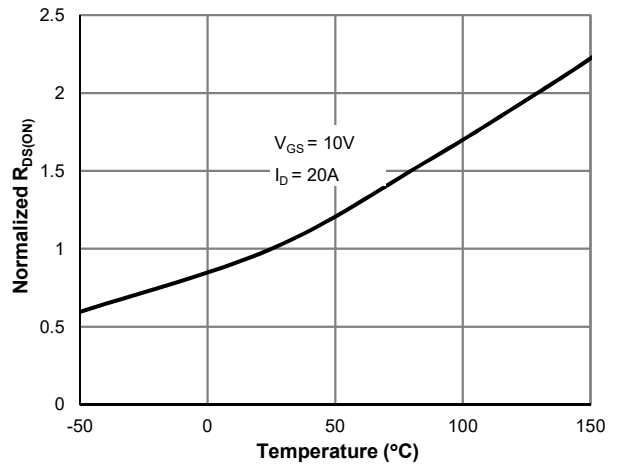
**Figure 1: Saturation Characteristics**



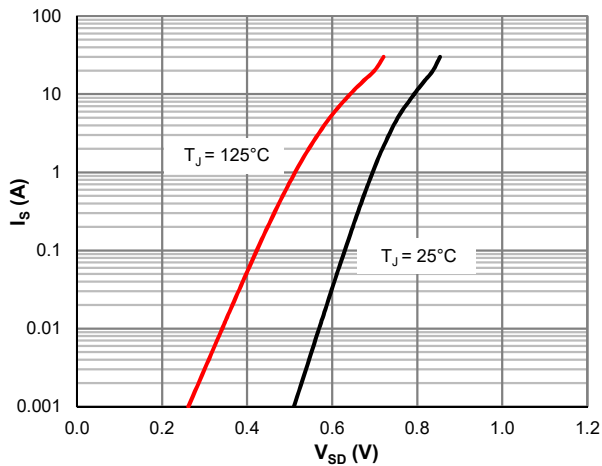
**Figure 2: Transfer Characteristics**



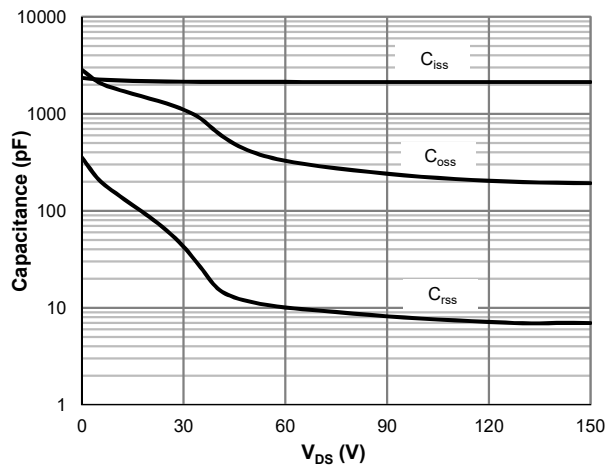
**Figure 3:  $R_{DS(ON)}$  vs. Drain Current**



**Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature**



**Figure 5: Body-Diode Characteristics**



**Figure 6: Capacitance Characteristics**

Typical Electrical & Thermal Characteristics

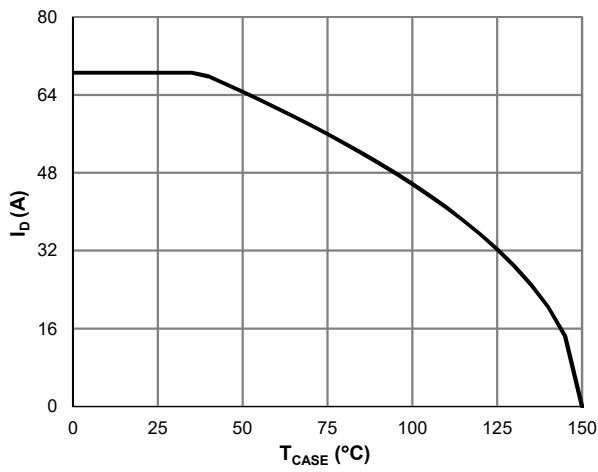


Figure 7: Current De-rating

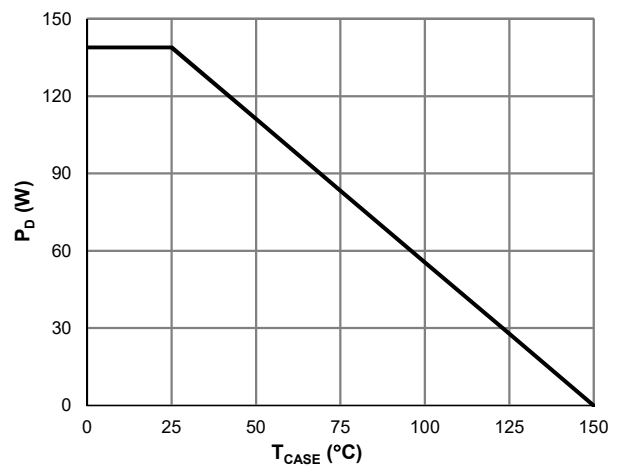


Figure 8: Power De-rating

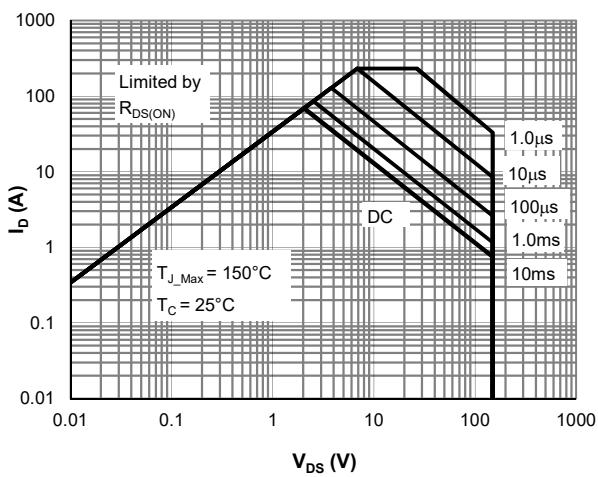


Figure 9: Maximum Safe Operating Area

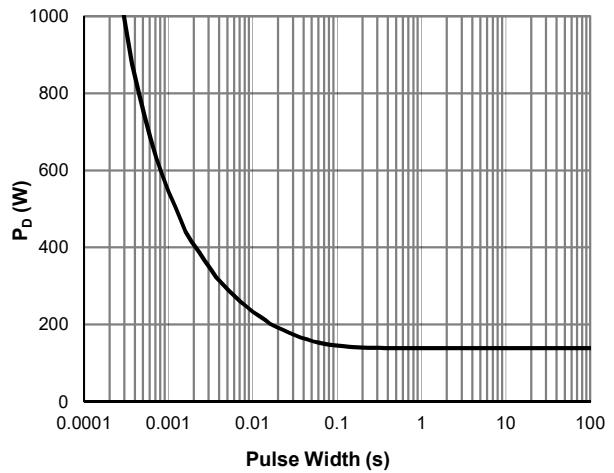


Figure 10: Single Pulse Power Rating, Junction-to-Case

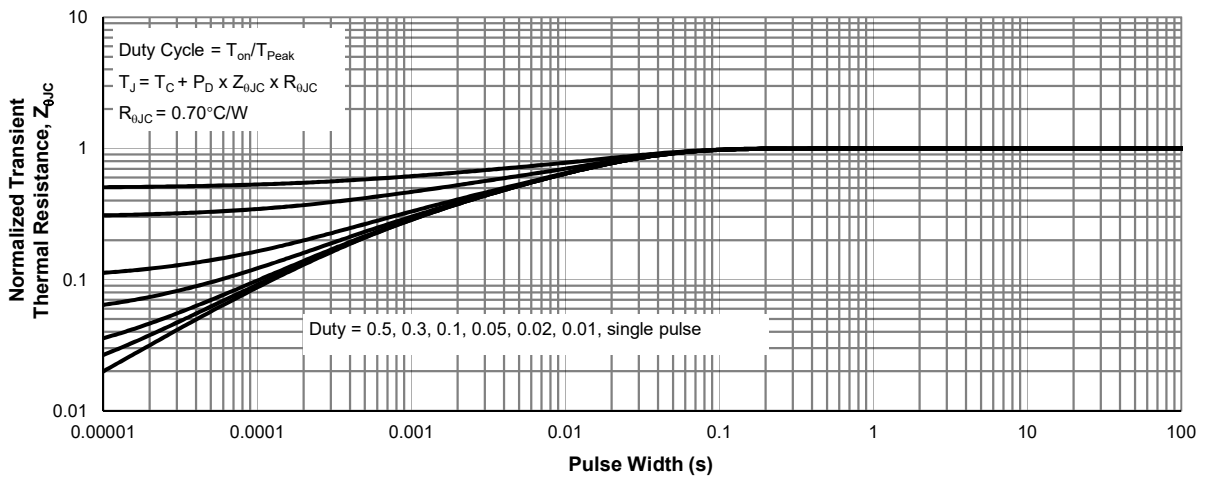
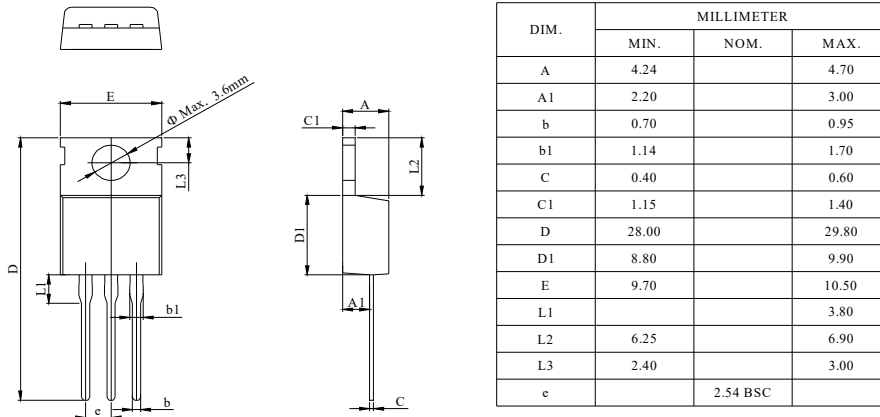


Figure 11: Normalized Maximum Transient Thermal Impedance

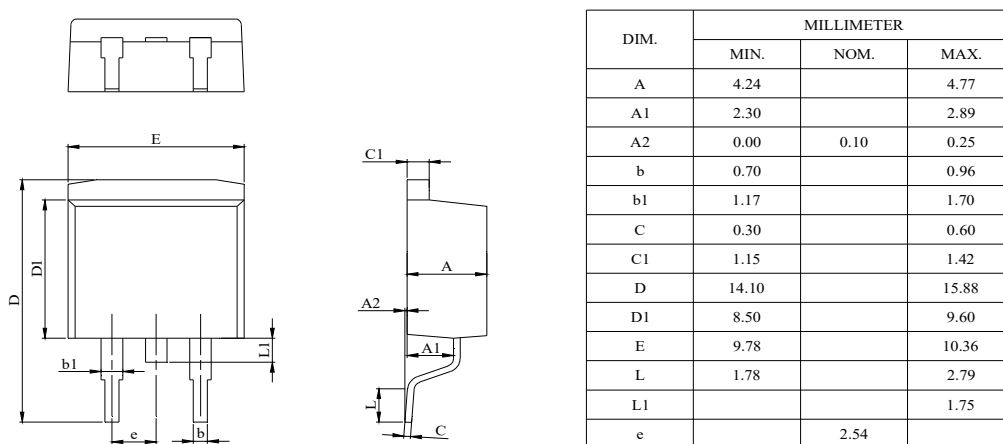
**TO-220-3L Package Information**

**Package Outline**



**TO-263-3L Package Information**

**Package Outline**



**Recommended Footprint**

